

Vishay High Power Products

FlipKY[®] Chip Scale Package Schottky Barrier Rectifier, 0.5 A



0.5 A

30 V

FEATURES • Ultra low V_F to footprint area

- Very low profile (< 0.6 mm)
- Low thermal resistance
- · Supplied tested and on tape and reel

APPLICATIONS

- Reverse polarity protection
- Current steering
- Freewheeling
- Flyback
- Oring

DESCRIPTION

Vishay's FlipKY[®] product family utilizes wafer level chip scale packaging to deliver Schottky diodes with the lowest V_F to PCB footprint area in industry. The three pad 0.9 mm x 1.2 mm devices can deliver up to 0.5 A and occupy only 1.08 mm² of board space. The anode and cathode connections are made through solder bump pads on one side of the silicon enabling designers to strategically place the diodes on the PCB. This design not only minimizes board space but also reduces thermal resistance and inductance, which can improve overall circuit efficiency.

Typical applications include hand-held, portable equipment such as cell phones, MP3 players, bluetooth, GPS, PDAs, and portable hard disk drives where space savings and performance are crucial.

MAJOR RATINGS AND CHARACTERISTICS					
SYMBOL	CHARACTERISTICS	MAX.	UNITS		
V _{RRM}		30	V		
I _{F(AV)}	Rectangular waveform	0.5	•		
I _{FSM}		190	— A		
V _F	0.5 Apk, T _J = 125 °C	0.33	V		
TJ		- 55 to 150	°C		

VOLTAGE RATINGS					
PARAMETER	SYMBOL	FCSP0530TR	UNITS		
Maximum DC reverse voltage	V _R	30	V		
Maximum working peak reverse voltage	V _{RWM}	30	v		

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PRODUCT SUMMARY

I_{F(AV)}

 V_{R}



FCSP0530TR



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ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum average forward current	I _{F(AV)}	50 % duty cycle at T _{PCB} = 133 °C, rectangular waveform		0.5	
Maximum peak one cycle	I _{FSM}	5 µs sine or 3 µs rect. pulse	Following any rated load condition and with rated V _{RRM} applied	190	А
non-repetitive surge current at 25 °C		10 ms sine or 6 ms rect. pulse		10	
Non-repetitive avalanche energy	E _{AS}	$T_J = 25 \text{ °C}, I_{AS} = 2.0 \text{ A}, L = 5.0 \text{ mH}$		5	mJ
Repetitive avalanche current	I _{AR}	Current decaying linearly to zero in 1 μ s Frequency limited by T _J maximum V _A = 1.5 x V _R typical		0.5	А

ELECTRICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS		TYP.	MAX.	UNITS
	V _{FM} ⁽¹⁾	0.5 A	T _J = 25 °C	0.40	0.44	V
Maximum forward voltage drop		1 A		0.45	0.49	
See fig. 1		0.5 A	- T _J = 125 °C	0.29	0.33	
		1 A		0.36	0.39	
Maximum reverse leakage current See fig. 2	I _{RM} ⁽¹⁾	T _J = 25 °C	V _R = Rated V _R	10	50	μA
		T _J = 125 °C		5	15	mA
Maximum junction capacitance	CT	$V_{R} = 5 V_{DC}$ (test signal range 100 kHz to 1 MHz) 25 °C		-	90	pF
Maximum voltage rate of change	dV/dt	Rated V _R		-	10 000	V/µs

Note

 $^{(1)}\,$ Pulse width < 300 $\mu s,$ duty cycle < 2 %

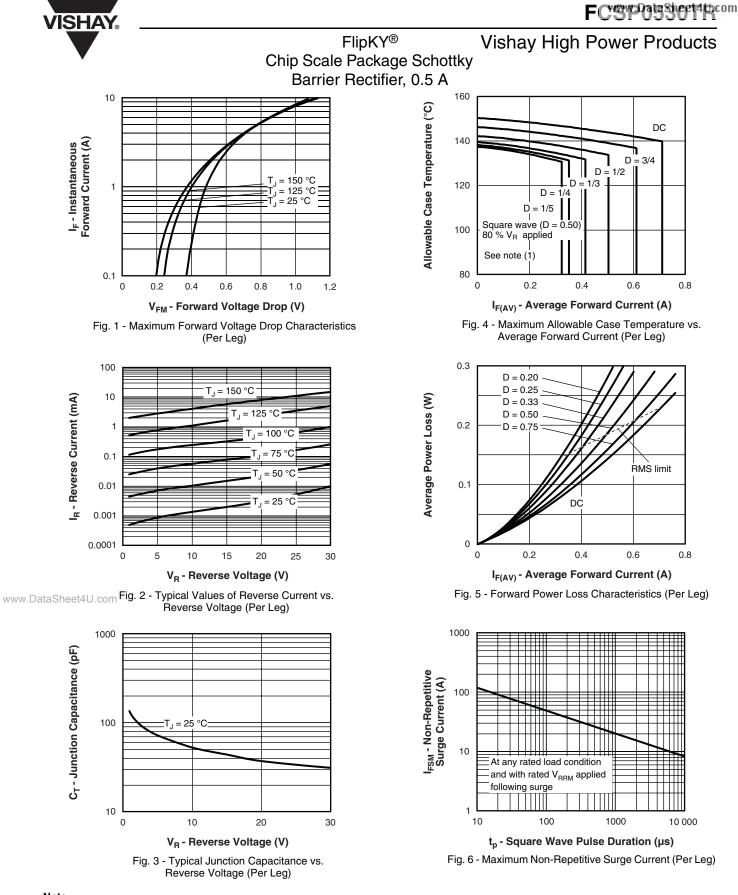
THERM	THERMAL - MECHANICAL SPECIFICATIONS					
PARAME	TER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
www.DataSheet40 temperatu	junction and storage re range	T _J ⁽¹⁾ , T _{Stg}		- 55 to 150	°C	
Typical the junction to	ermal resistance, PCB	R _{thJL} ⁽²⁾	DC operation	35	°C/W	
Typical the junction to	ermal resistance, ambient	R _{thJA}		150	0/10	

Notes

(1)

 $\frac{dP_{tot}}{dT_J} < \frac{1}{R_{thJA}}$ thermal runaway condition for a diode on its own heatsink

⁽²⁾ Mounted on minimum footprint PCB



Note

⁽¹⁾ Formula used: $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$;

Pd = Forward power loss = I_{F(AV)} x V_{FM} at (I_{F(AV)}/D) (see fig. 6); Pd_{REV} = Inverse power loss = V_{R1} x I_R (1 - D); I_R at 80 % V_R applied

FCSP0530TR



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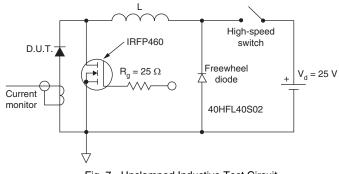


Fig. 7 - Unclamped Inductive Test Circuit

LINKS TO RELATED DOCUMENTS				
Dimensions	http://www.vishay.com/doc?95049			
Part marking information	http://www.vishay.com/doc?95060			
Packaging information	http://www.vishay.com/doc?95062			

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